

MT62F4G32D8DV-O23 IT:B

Documents

Data Sheet
Reach Statement
RoHS
Sim Model

Specifications

Component Density 128Gb	Speed 4266MHz	MT/s 8533MTPS	I/O Voltage 0.5 VOLTS	Operating Temp -40C to +95C	Bus Width x32
CAS Latency CL = Programmable	Pin Count 315-ball	Part Status Code Production	Component Config 4G x32	Dry Pack Qty 1050	Package Dimension (W x L x H) mm 12.40 x 15.00 x 1.30
Tape & Reel Qty 2000	Package Type GREEN	Number of Components 8	Package LFBGA	Family DRAM	Technology LPDDR5